

Features

- ► Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{ISS} and fast switching speeds
- Excellent thermal stability
- ► Integral source-drain diode
- ► High input impedance and high gain
- ► Complementary N- and P-Channel devices

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

General Description

The Supertex 2N7000 is an enhancement-mode (normally-off) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Option	BV _{DSS} /BV _{DGS} (V)	R _{DS(ON)} (max) (Ω)	l _{D(ON)} (min) (mA)	
2N7000-G	TO-92	60	5.0	75	





-G indicates package is RoHS compliant ('Green')

Absolute Maximum Ratings

Parameter	Value			
Drain-to-source voltage	BV _{DSS}			
Drain-to-gate voltage	BV _{DGS}			
Gate-to-source voltage	±30V			
Operating and storage temperature	-55°C to +150°C			
Soldering temperature*	+300°C			

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Pin Configuration





YY = Year Sealed WW = Week Sealed ____ = "Green" Packaging

TO-92

^{*} Distance of 1.6mm from case for 10 seconds.

Thermal Characteristics

Package	I _D (continuous) [†] (mA)	I _D (pulsed) (mA)	Power Dissipation @T _c = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	_{DR}	l _{DRM} (mA)	
TO-92	200	500	1.0	125	170	200	500	

Notes:

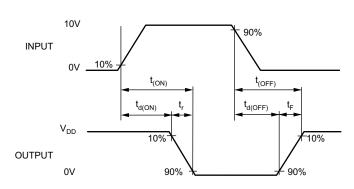
Electrical Characteristics (T_A = 25°C unless otherwise specified)

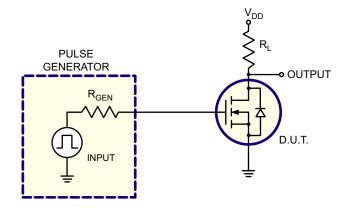
Sym	Parameter		Тур	Max	Units	Conditions	
BV _{DSS}	Drain-to-source breakdown voltage	60	-	-	V	$V_{GS} = 0V, I_{D} = 10\mu A$	
$V_{GS(th)}$	Gate threshold voltage		-	3.0	V	$V_{GS} = V_{DS}$, $I_D = 1.0 \text{mA}$	
I _{GSS}	Gate body leakage current	-	-	10	nA	$V_{GS} = \pm 15V, V_{DS} = 0V$	
		-	-	1.0	μA	$V_{GS} = 0V$, $V_{DS} = 48V$	
I _{DSS}	Zero gate voltage drain current		-	1.0	mA	$V_{GS} = 0V, V_{DS} = 48V,$ $T_A = 125^{\circ}C$	
I _{D(ON)}	On-state drain current	75	-	-	mA	V _{GS} = 4.5V, V _{DS} = 10V	
В	Static drain-to-source	-	-	5.3	Ω	$V_{GS} = 4.5V, I_{D} = 75mA$	
R _{DS(ON)}	on-state resistance	-	-	5.0	12	$V_{GS} = 10V, I_{D} = 500mA$	
G _{FS}	Forward transconductance	100	-	-	mmho	V _{DS} = 10V, I _D = 200mA	
C _{ISS}	Input capacitance	-	-	60			
C _{oss}	Common source output capacitance	-	-	25	pF	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1.0MHz	
C _{RSS}	Reverse transfer capacitance	-	-	5			
t _(ON)	Turn-on time	-	-	10	20	$V_{DD} = 15V, I_{D} = 500 \text{mA},$	
t _(OFF)	Turn-off time	-	-	10	ns	$R_{GEN}^{DD} = 25\Omega^{D}$	
V _{SD}	Diode forward voltage drop	-	0.85	-	V	V _{GS} = 0V, I _{SD} = 200mA	

Notes:

- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

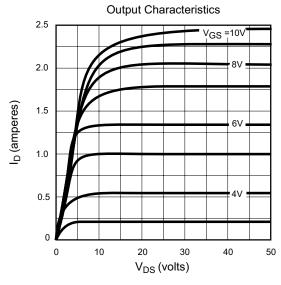
Switching Waveforms and Test Circuit

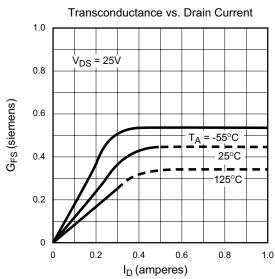


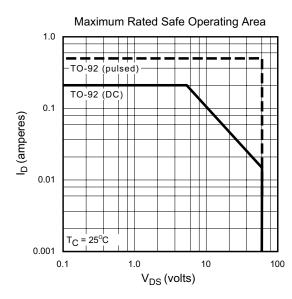


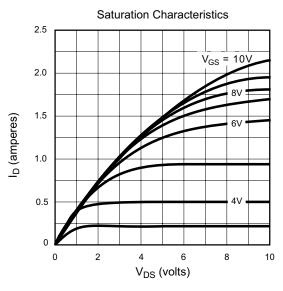
[†] I_D (continuous) is limited by max rated T_T

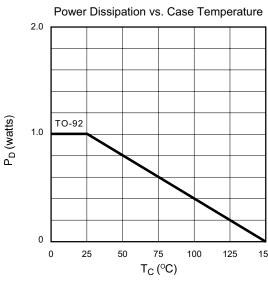
Typical Performance Curves

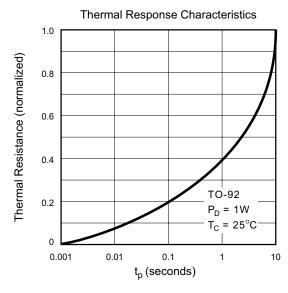




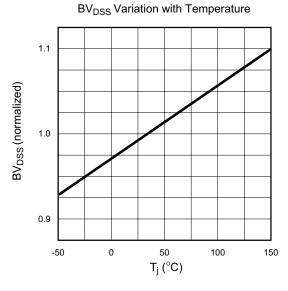


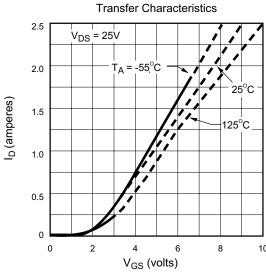


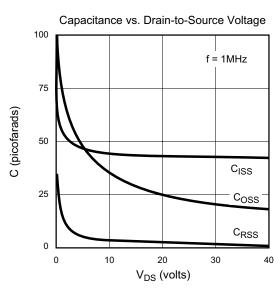


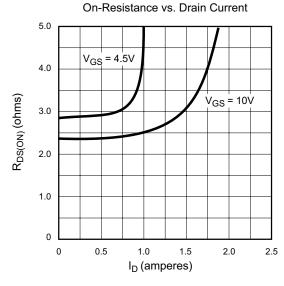


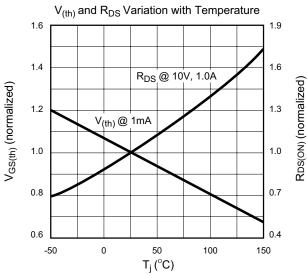
Typical Performance Curves (cont.)

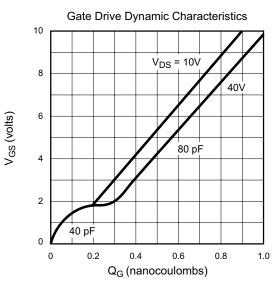




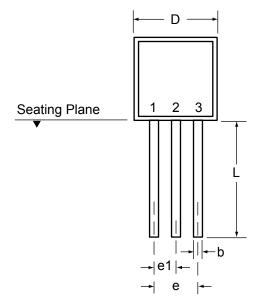


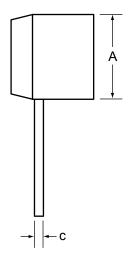






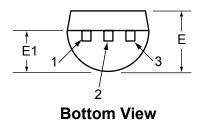
3-Lead TO-92 Package Outline (N3)





Front View

Side View



Symbol		Α	b	С	D	E	E1	е	e1	L
Dimensions (inches)	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version D080408.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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^{*} This dimension is not specified in the original JEDEC drawing. The value listed is for reference only.

[†] This dimension is a non-JEDEC dimension.